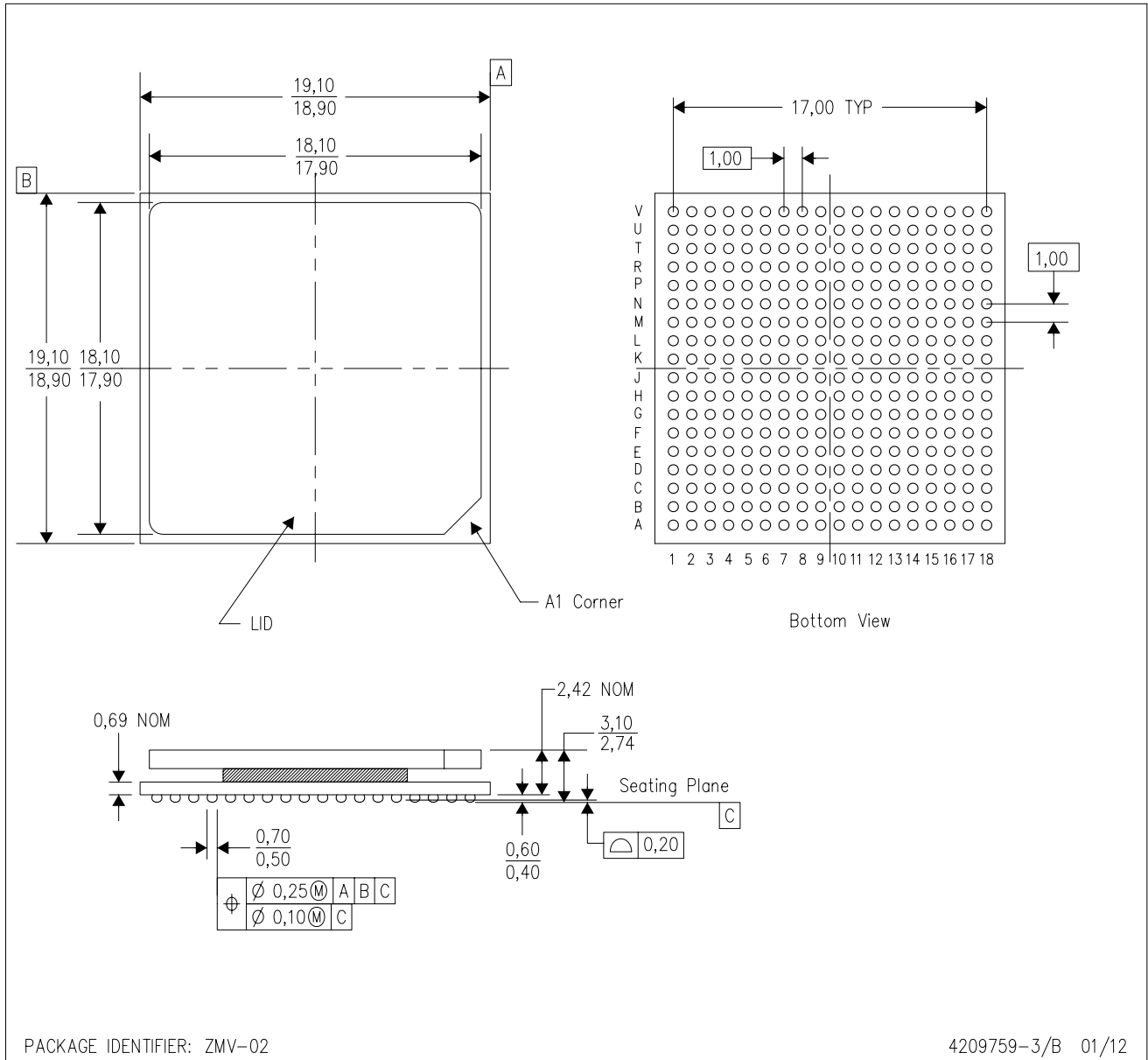


ZMV (S-PBGA-N324)

PLASTIC BALL GRID ARRAY



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Thermally enhanced plastic package with heat slug (HSL).
  - D. Flip chip application only.
  - E. This is a Pb-free solder ball design.

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